
**T2513BK –
T2513NK TRIACS**
**25.0 A 200–800 V
50/50/50/75 mA**

The T2513 series isolated TRIAC's are high performance glass passivated PNPN devices. These parts are intended for high volume, very high current applications where high gate insensitivity is required.

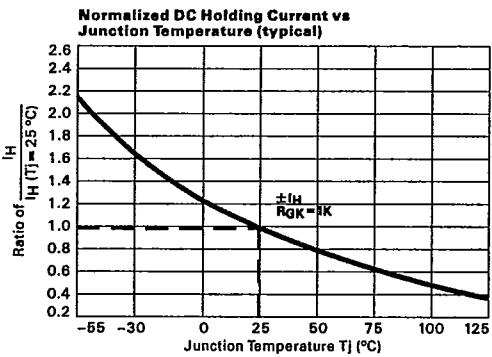
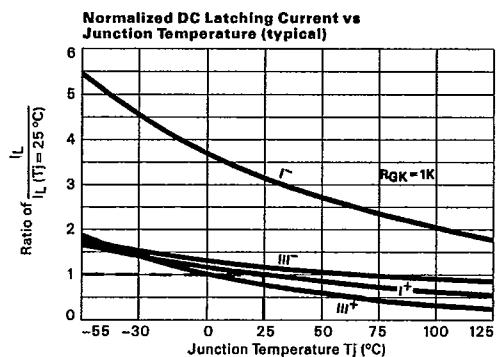
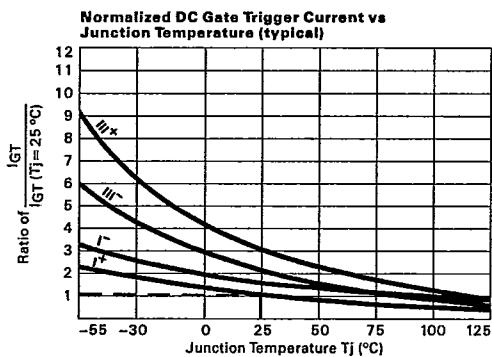
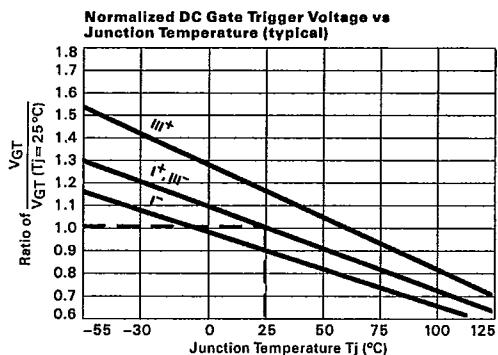
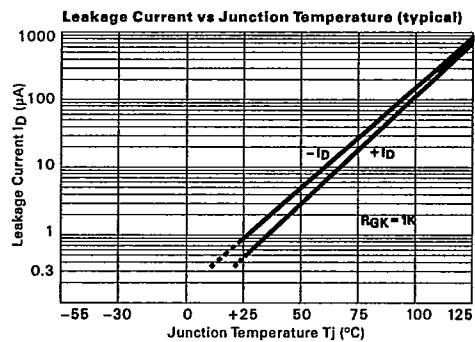
U. L. Recognized, File Nr. E72763 (M)

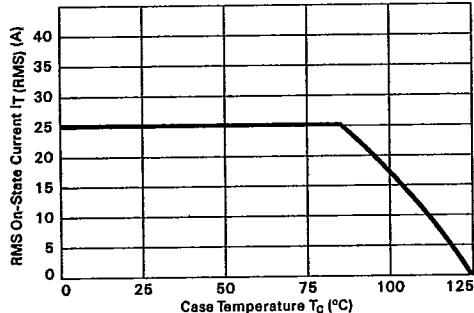
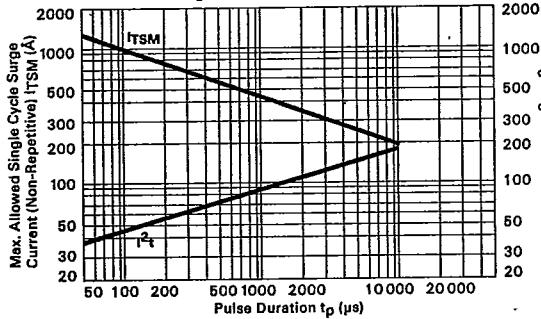
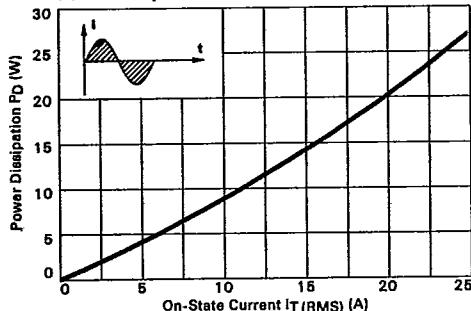
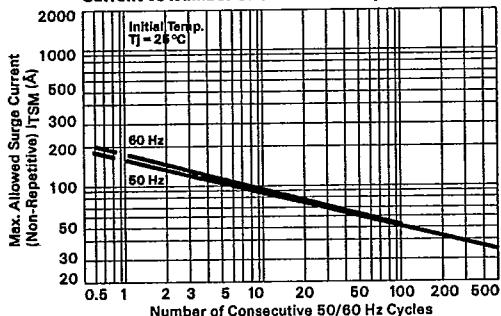
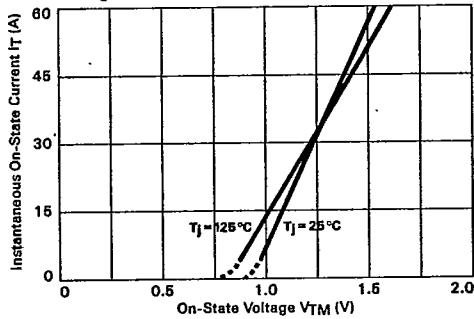
Absolute Maximum Ratings $T_A = 25^\circ\text{C}$ unless otherwise noted

Parameter	Part Nr.	Symbol	Min.	Max.	Unit	Test Conditions
Repetitive Peak Off State Voltage	T2513BK	V_{DRM}	200		V	$T_j = -40^\circ\text{C} \text{ to } 125^\circ\text{C}$ $R_{GK} = 1\text{ k}\Omega$
	T2513DK		400		V	
	T2513MK		600		V	
	T2513NK		800		V	
On-State Current		$I_T(\text{RMS})$	25		A	All Conduction Angles $T_C = 85^\circ\text{C}$
Nonrept. On-State Current		I_{TSM}	210		A	Half Cycle, 60 Hz
Nonrept. On-State Current		I_{TSM}	190		A	Half Cycle, 50 Hz
Fusing Current		I^2t	180		A^2s	$t = 10\text{ ms}$
Peak Gate Current		I_{GM}	4		A	$10\mu\text{s}$ max.
Peak Gate Dissipation		P_{GM}	10		W	$10\mu\text{s}$ max.
Gate Dissipation		$P_G(\text{AV})$	1		W	20 ms max.
Isolation Voltage		V_{iso}	2500		VAC	
Operating Temperature	T_j	-40	125		$^\circ\text{C}$	
Storage Temperature	T_{stg}	-40	125		$^\circ\text{C}$	
Soldering Temperature	T_{sld}		250	$^\circ\text{C}$		1.6 mm from case, 10 s max.

Electrical Characteristics $T_A = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Min.	Max.	Unit	Test Conditions
Off-State Leakage Current	I_{DRM}	3		mA	$V_D = V_{DRM}$ $R_{GK} = 1\text{ k}\Omega$ $T_j = 125^\circ\text{C}$
Off-State Leakage Current	I_{DRM}	10		μA	$V_D = V_{DRM}$ $R_{GK} = 1\text{ k}\Omega$ $T_j = 25^\circ\text{C}$
On-State Voltage	V_T	1.4		V	at $I_T = 37.5\text{ A}$, $T_j = 25^\circ\text{C}$
On-State Threshold Voltage	$V_{T(TO)}$	0.85		V	$T_j = 125^\circ\text{C}$
On-State Slope Resistance	r_T	12		$\text{m}\Omega$	$T_j = 125^\circ\text{C}$
Gate Trigger Current	$I_{GT\text{ I+}}$ (1)	50		mA	$V_D = 12\text{ V}$
	$I_{GT\text{ I-}}$ (2)	50		mA	$V_D = 12\text{ V}$
	$I_{GT\text{ III-}}$ (3)	50		mA	$V_D = 12\text{ V}$
	$I_{GT\text{ III+}}$ (4)	75		mA	$V_D = 12\text{ V}$
Gate Trigger Voltage	V_{GT}	2.5		V	$V_D = 12\text{ V}$ All Quadrants
Holding Current	I_H	75		mA	$R_{GK} = 1\text{ k}\Omega$
Critical Rate of Voltage Rise	dv/dt	500		$\text{V}/\mu\text{s}$	$V_D = .67 \times V_{DRM}$ $R_{GK} = 1\text{ k}\Omega$ $T_j = 125^\circ\text{C}$
Critical Rate of Rise, Off-State	dv/dt_c	5		$\text{V}/\mu\text{s}$	$I_T = 25\text{ A}$ $v_{D(on)} = 11\text{ V}$ $t_c = 10\text{ ms}$ $T_j = 85^\circ\text{C}$
Thermal Resistance junc. to case	$R_{\Theta jc}$	1.5		K/W	



RMS On-State Current vs Case Temperature**Max. Allowed Single Cycle Surge (On-State) Current vs Surge Current Duration****Power Dissipation vs On-State Current****Max. Allowed Multi Cycle Surge (On-State) Current vs Number of Consecutive Cycles****Instantaneous On-State Current vs On-State Voltage with Junction Temperature as Parameter****Max. All. Power Dissip. vs Ambient Temp. with given Heatsink Thermal Resistances as Parameter**